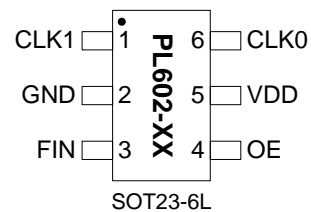
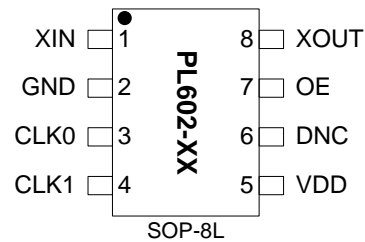


HCSL Compatible Clock Generator for PCI Express

FEATURES

- Input Frequency:
 - Fundamental Crystal or Reference Input: 25MHz
- Output Frequency:
 - PL602-21: 100MHz differential outputs.
 - PL602-22: 125MHz differential outputs.
 - PL602-23: 200MHz differential outputs.
 - PL602-26: 25MHz differential outputs.
 - PL602-27: 250MHz differential outputs.
 - PL602-15: 156.25 MHz differential outputs.
- Very low Jitter: 28ps Pk-Pk typ.
- Very low Phase Noise:
 - -130 dBc at 10kHz offset at 100MHz
- No external loop filter is required
- Power supply range: 2.25V to 3.63V
- Operating temperature range from -40°C to 85°C
- Available in 6-pin SOT or 8-pin SOP Green/RoHS compliant package.

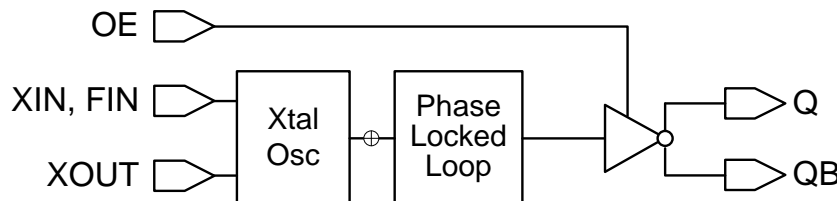
PIN CONFIGURATION



DESCRIPTION

The PL602-XX is the smallest, high performance, lowest power differential output clock IC available for HCSL timing applications. PL602-XX offers -130dBc at 10kHz offset at 100MHz, with a very low jitter (2 ps TIE RMS), making it ideal for HCSL applications requiring small size and low power.

BLOCK DIAGRAM



PIN DESCRIPTION

| Name | Pin # | | Type | Description |
|----------|-------|-------|------|---|
| | SOP | SOT23 | | |
| XIN | 1 | - | I | Crystal input (SOP package only) |
| FIN | - | 3 | I | Reference clock input (SOT23 package only) |
| GND | 2 | 2 | P | GND connection |
| CLK[0:1] | 3,4 | 1,6 | O | Differential clock outputs [note:CLK0=~CLK1] |
| VDD | 5 | 5 | P | VDD connection |
| DNC | 6 | - | - | Do not connect |
| OE | 7 | 4 | I | Output enable (OE) input. Internal 60KΩ pull up resistor. |
| XOUT | 8 | - | O | Crystal output pin. |

HCSL Compatible Clock Generator for PCI Express
ELECTRICAL SPECIFICATIONS
ABSOLUTE MAXIMUM RATINGS

| PARAMETERS | SYMBOL | MIN. | MAX. | UNITS |
|--------------------------------|----------|------|--------------|-------|
| Supply Voltage Range | V_{DD} | -0.5 | 4.6 | V |
| Input Voltage Range | V_I | -0.5 | $V_{DD}+0.5$ | V |
| Output Voltage Range | V_O | -0.5 | $V_{DD}+0.5$ | V |
| Soldering Temperature | | | 260 | °C |
| Storage Temperature | T_S | -65 | 150 | °C |
| Ambient Operating Temperature* | | -40 | +85 | °C |

Exposure of the device under conditions beyond the limits specified by Maximum Ratings for extended periods may cause permanent damage to the device and affect product reliability. These conditions represent a stress rating only, and functional operations of the device at these or any other conditions above the operational limits noted in this specification is not implied. *Operating temperature is guaranteed by design. Parts are tested to commercial grade only.

AC SPECIFICATIONS

| PARAMETERS | CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|-------------------------------------|---|------|------|----------|-------|
| Crystal Input Frequency | Fundamental Crystal | | 25 | | MHz |
| Input (F_{IN}) Frequency | | | 25 | | MHz |
| Input (F_{IN}) Signal Amplitude | Internally AC coupled | 0.9 | | V_{DD} | Vpp |
| Output Frequency | | 25 | | 200 | MHz |
| Output Enable Time | OE Function; $T_a=25^\circ\text{C}$, Add one clock period to this measurement for a usable clock output. | | | 10 | ns |
| Output Disable Time | OE Function; $T_a=25^\circ\text{C}$ | | | 10 | ns |
| Settling Time | At power-up ($V_{DD} \geq 2.25\text{V}$) | | | 10 | ms |
| VDD Sensitivity | Frequency vs. V_{DD} , $\pm 10\%$ | -2 | | 2 | ppm |
| Output Rise Time | 10/90% V_{OH} | | 0.3 | 0.5 | ns |
| Output Fall Time | 90/10% V_{OH} | | 0.3 | 0.5 | ns |
| Skew Between Outputs | Measured at 50% V_{OH} | | | 250 | ps |
| Duty Cycle | At $V_{DD}/2$ | 45 | 50 | 55 | % |
| Period Jitter, peak-to-peak | - With capacitive decoupling between V_{DD} and GND - At 100MHz - 20,000 samples measured | | 28 | | ps |
| Cycle-to-Cycle, RMS | | | 9 | | ps |
| Cycle-to-Cycle, peak | | | 25 | | ps |
| TIE, RMS | | | 2 | | ps |

HCSL Compatible Clock Generator for PCI Express
DC SPECIFICATIONS

| PARAMETERS | SYMBOL | CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|-------------------------|-----------|---|------|------|------|-------|
| Supply Current, Dynamic | I_{DD} | At 100MHz, No Load | | 25 | | mA |
| Operating Voltage | V_{DD} | | 2.25 | | 3.63 | V |
| Output Low Voltage | V_{OL} | HCSL termination, (RS = 150Ω, RT = 49.9Ω) 3.3V (RS = 100Ω, RT = 49.9Ω) 2.5V | | | 0.05 | V |
| Output High Voltage | V_{OH} | | 0.65 | 0.75 | 0.85 | V |
| Output Current | I_{OSD} | | 13 | 15 | 17 | mA |

CRYSTAL SPECIFICATIONS

| PARAMETERS | SYMBOL | MIN. | TYP. | MAX. | UNITS |
|--|--------------|------|------|------|-------|
| Fundamental Crystal Resonator Frequency | F_{XIN} | | 25 | | MHz |
| Crystal Loading Rating | $C_L (xtal)$ | | 18 | | pF |
| Maximum Sustainable Drive Level | | | | 500 | μW |
| Operating Drive Level | | | 100 | | μW |
| Crystal Shunt Capacitance | C0 | | | 6 | pF |
| Effective Series Resistance, Fundamental | ESR | | | 45 | Ω |

HCSL Compatible Clock Generator for PCI Express

PCI EXPRESS/HCSL COMPATIBLE LAYOUT GUIDELINES

Figure 1 below describes how to terminate the complementary LVCMOS outputs of PL602-XX for use with HCSL inputs.

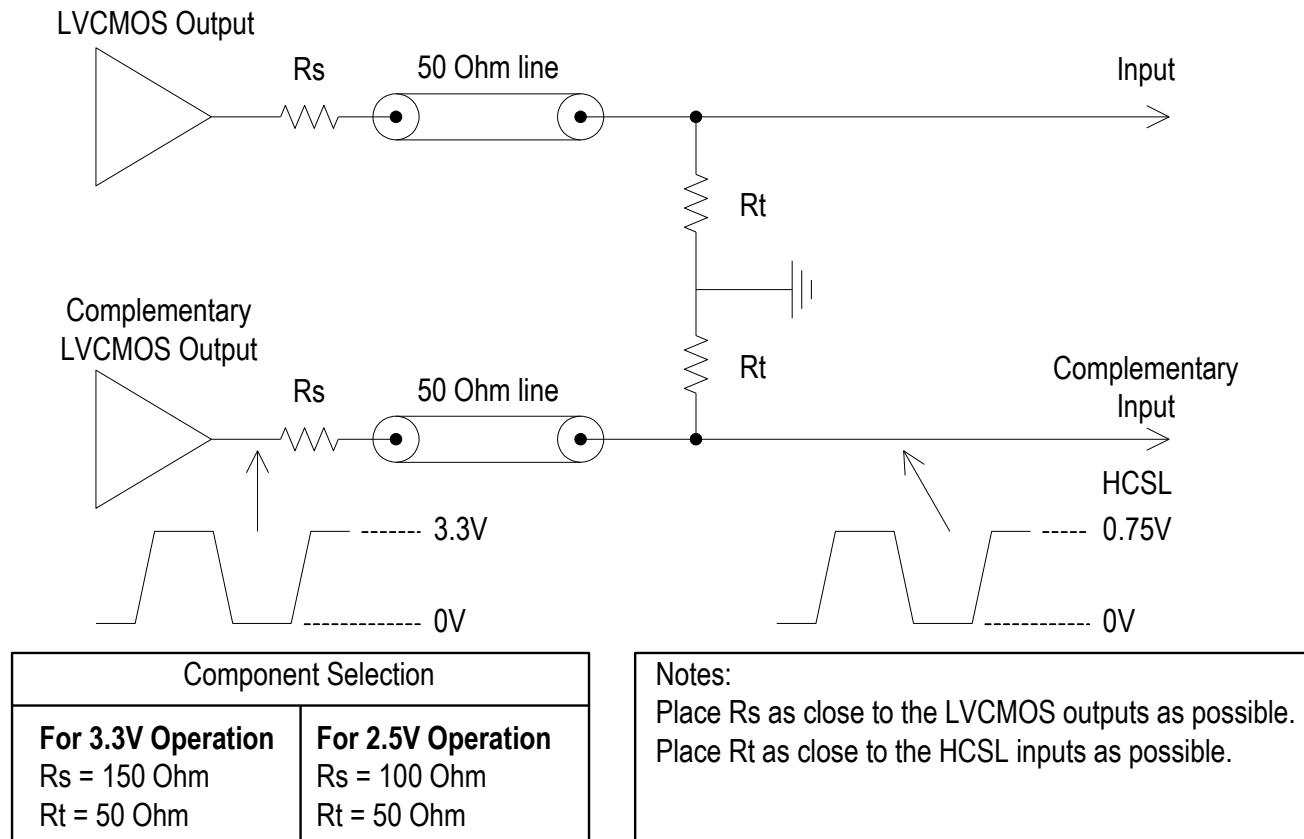


Figure 1

PCB LAYOUT CONSIDERATIONS FOR PERFORMANCE OPTIMIZATION

The following guidelines are to assist you with a performance optimized PCB design:

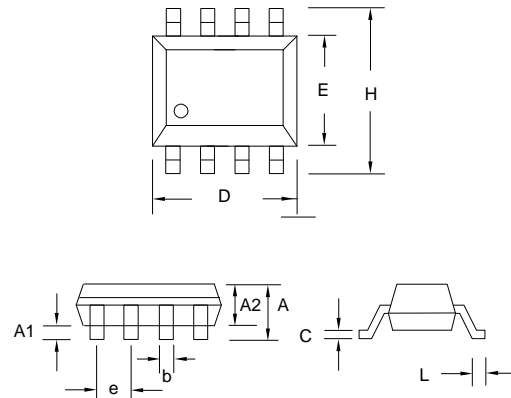
- Keep all the PCB traces to PL602-XX as short as possible, as well as keeping all other traces as far away from it as possible.
- Place the crystal as close as possible to both crystal pins of the device. This will reduce the cross-talk between the crystal and the other signals.
- Separate crystal pin traces from the other signals on the PCB, but allow ample distance between the two crystal pin traces.
- Place a $0.01\mu\text{F} \sim 0.1\mu\text{F}$ decoupling capacitor between VDD and GND, on the component side of the PCB, close to the VDD pin. It is not recommended to place this component on the backside of the PCB.
- It is highly recommended to keep the VDD and GND traces as short as possible.
- When connecting long traces (> 1 inch) to a CMOS output, it is important to design the traces as a transmission line or 'stripline', to avoid reflections or ringing. In this case, the CMOS output needs to be matched to the trace impedance. Usually 'striplines' are designed for 50Ω impedance and CMOS outputs usually have lower than 50Ω impedance so matching can be achieved by adding a resistor in series with the CMOS output pin to the 'stripline' trace.

HCSL Compatible Clock Generator for PCI Express

PACKAGE DRAWINGS (GREEN PACKAGE COMPLIANT)

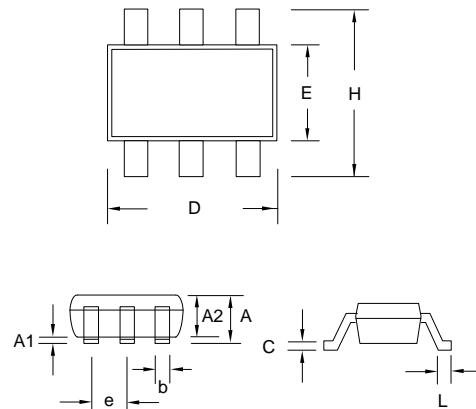
SOP-8L

| Symbol | Dimension in MM | |
|--------|-----------------|------|
| | Min. | Max. |
| A | 1.35 | 1.75 |
| A1 | 0.10 | 0.25 |
| A2 | 1.25 | 1.50 |
| B | 0.33 | 0.53 |
| C | 0.19 | 0.27 |
| D | 4.80 | 5.00 |
| E | 3.80 | 4.00 |
| H | 5.80 | 6.20 |
| L | 0.40 | 0.89 |
| e | 1.27 BSC | |



SOT23-6L

| Symbol | Dimension in MM | |
|--------|-----------------|------|
| | Min. | Max. |
| A | 1.05 | 1.35 |
| A1 | 0.05 | 0.15 |
| A2 | 1.00 | 1.20 |
| B | 0.30 | 0.50 |
| C | 0.08 | 0.20 |
| D | 2.80 | 3.00 |
| E | 1.50 | 1.70 |
| H | 2.60 | 3.0 |
| L | 0.35 | 0.55 |
| e | 0.95 BSC | |



HCSL Compatible Clock Generator for PCI Express

ORDERING INFORMATION (GREEN PACKAGE COMPLIANT)

For part ordering, please contact our Sales Department:

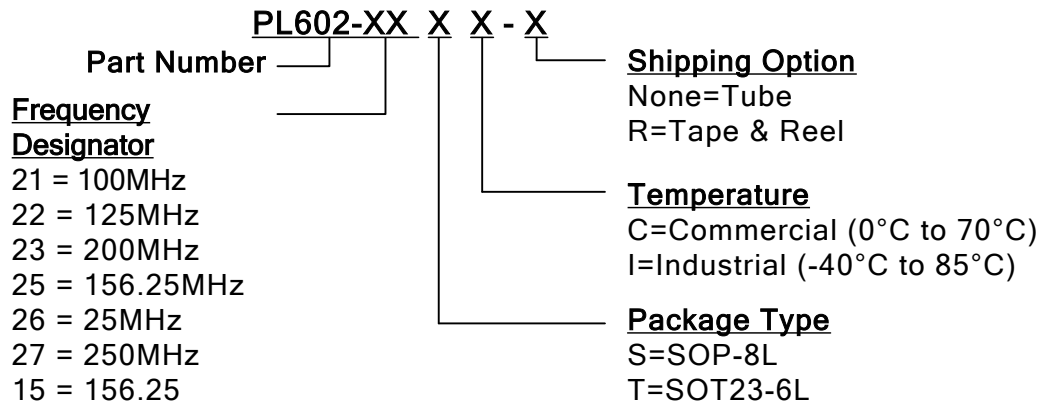
2180 Fortune Drive, San Jose, CA 95131, USA

Tel: (408) 944-0800 Fax: (408) 474-1000

PART NUMBER

The order number for this device is a combination of the following:

Part number, Package type and Operating temperature range



| Part / Order Number | Marking | Package Option |
|---------------------|---------------|------------------------------|
| PL602-2XSC | P602-2X SC | 8-Pin SOP (Tube) |
| PL602-2XSC-R | LLLLL | 8-Pin SOP (Tape and Reel) |
| PL602-1XTC-R | F1X LLL | 6-Pin SOT-23 (Tape and Reel) |
| PL602-2XTC-R | F2X LLL | 6-Pin SOT-23 (Tape and Reel) |

Note: LLL / LLLLL designate Production Lot.

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